April 2000 PRELIMINARY

FDW2503N

FAIRCHILD

Dual N-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

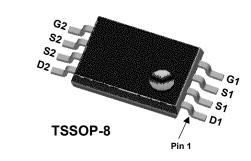
This N-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild's Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

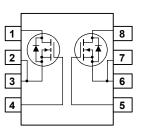
Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

Features

- 5.5 A, 20 V. $R_{DS(ON)} = 0.021 \ \Omega \ @ V_{GS} = 4.5 \ V$ $R_{DS(ON)} = 0.035 \ \Omega \ @ V_{GS} = 2.5 \ V$
- Extended V_{GSS} range (±12V) for battery applications
- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		±12	V
ID	Drain Current – Continuous	(Note 1a)	5.5	А
	– Pulsed		30	
PD	Power Dissipation	(Note 1a)	1.0	W
		(Note 1b)	0.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	al Characteristics	<u>.</u>		
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	125	°C/W
		(Note 1b)	208	

Device Marking	Device	Reel Size	Tape width	Quantity
2503N	FDW2503N	13"	12mm	3000 units

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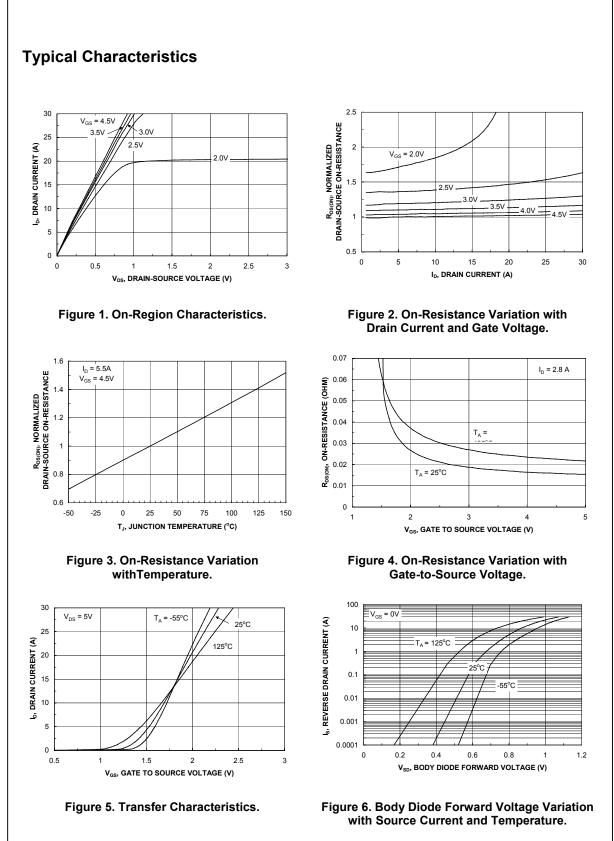
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics		•	•	•	
BV _{DSS}	Drain–Source Breakdown Voltage	V_{GS} = 0 V, I_{D} = 250 μ A	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA,Referenced to 25°C		14		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 16 V$, $V_{GS} = 0 V$			1	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 12 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate–Body Leakage, Reverse	V _{GS} = -12 V V _{DS} = 0 V			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.6	0.8	1.5	V
<u>ΔV_{GS(th)}</u> ΔT _J	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA,Referenced to 25°C		-3.2		mV/°0
R _{DS(on)}	Static Drain–Source	$V_{GS} = 4.5 V$, $I_D = 5.5 A$		17	21	mΩ
	On–Resistance	$V_{GS} = 2.5 V$, $I_D = 4.2 A$		22	35	
		V_{GS} = 4.5 V, I_D = 5.5A, T_J =125°C		23	29	
D(on)	On–State Drain Current	$V_{GS} = 4.5 V, V_{DS} = 5 V$	30			A
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 5.5 A$		26		S
-	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 5.5 A$		26		S
-				26 1082		S pF
Dynamio	c Characteristics	$V_{DS} = 5 V$, $I_D = 5.5 A$ $V_{DS} = 10 V$, $V_{GS} = 0 V$, $f = 1.0 MHz$				
Dynami C _{iss}	C Characteristics	V _{DS} = 10 V, V _{GS} = 0 V,		1082		pF
Dynamie C _{iss} C _{oss} C _{rss}	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 10 V, V _{GS} = 0 V,		1082 277		pF pF
Dynamie C _{iss} C _{oss} C _{rss} Switchir	c Characteristics Input Capacitance Output Capacitance	$V_{DS} = 10 V,$ $V_{GS} = 0 V,$ f = 1.0 MHz $V_{DD} = 10 V,$ $I_D = 1 A,$		1082 277	16	pF pF
Dynamie C _{iss} C _{oss} C _{rss} Switchir	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance g Characteristics (Note 2)	V _{DS} = 10 V, V _{GS} = 0 V,		1082 277 130	16	pF pF pF
Dynamic C _{iss} C _{oss} C _{rss} Switchir t _{d(on)}	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Ing Characteristics (Note 2) Turn-On Delay Time	$V_{DS} = 10 V,$ $V_{GS} = 0 V,$ f = 1.0 MHz $V_{DD} = 10 V,$ $I_D = 1 A,$		1082 277 130 8	-	pF pF pF ns
Dynamic Ciss Coss Crss Switchir td(on) tr	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Of Characteristics (Note 2) Turn-On Delay Time Turn-On Rise Time	$V_{DS} = 10 V,$ $V_{GS} = 0 V,$ f = 1.0 MHz $V_{DD} = 10 V,$ $I_D = 1 A,$		1082 277 130 8 8	16	pF pF pF ns ns
Dynamic Ciss Coss Crss Switchir td(on) tr td(off) tr	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time	$V_{DS} = 10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DD} = 10 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		1082 277 130 8 8 8 24	16 38	pF pF pF ns ns ns
Dynamic Ciss Coss Crss Switchir td(on) tr td(off) tr Qg	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Input Capacitance Reverse Transfer Capacitance Input Cap	$V_{DS} = 10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DD} = 10 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		1082 277 130 8 8 8 24 8	16 38 16	pF pF pF ns ns ns
Dynamic Ciss Coss Crss Switchir td(on) tr td(off) tr Qg Qgs	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time	$V_{DS} = 10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DD} = 10 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 10 \text{ V}, \qquad I_D = 5.5 \text{ A},$		1082 277 130 8 8 8 24 8 12	16 38 16	pF pF pF ns ns ns ns nc
Dynamic Ciss Coss Crss Switchir td(on) tr td(off) tr Qg Qgs Qgd	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance g Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge Gate–Drain Charge	$V_{DS} = 10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DD} = 10 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 10 \text{ V}, \qquad I_D = 5.5 \text{ A},$ $V_{GS} = 4.5 \text{ V}$		1082 277 130 8 8 8 24 8 12 2	16 38 16	pF pF pF ns ns ns nC nC
Dynamic Ciss Coss Crss Switchir td(on) tr td(off) td Qg Qgs Qgd	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance D Characteristics (Note 2) Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$V_{DS} = 10 V, V_{GS} = 0 V,$ f = 1.0 MHz $V_{DD} = 10 V, I_D = 1 A,$ $V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$ $V_{DS} = 10 V, I_D = 5.5 A,$ $V_{GS} = 4.5 V$ and Maximum Ratings		1082 277 130 8 8 8 24 8 12 2	16 38 16	pF pF pF ns ns ns nC nC

a) R_{θ,JA} is 125°C/W (steady state) when mounted on a 1 inch² copper pad on FR-4. b) R_{θ,JA} is 208°C/W (steady state) when mounted on a minimum copper pad on FR-4.

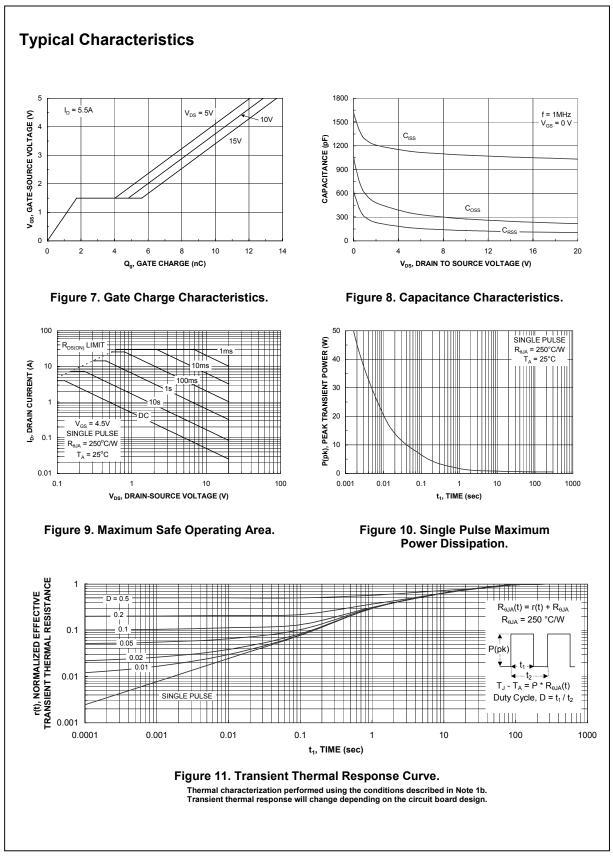
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDW2503N Rev. D (W)

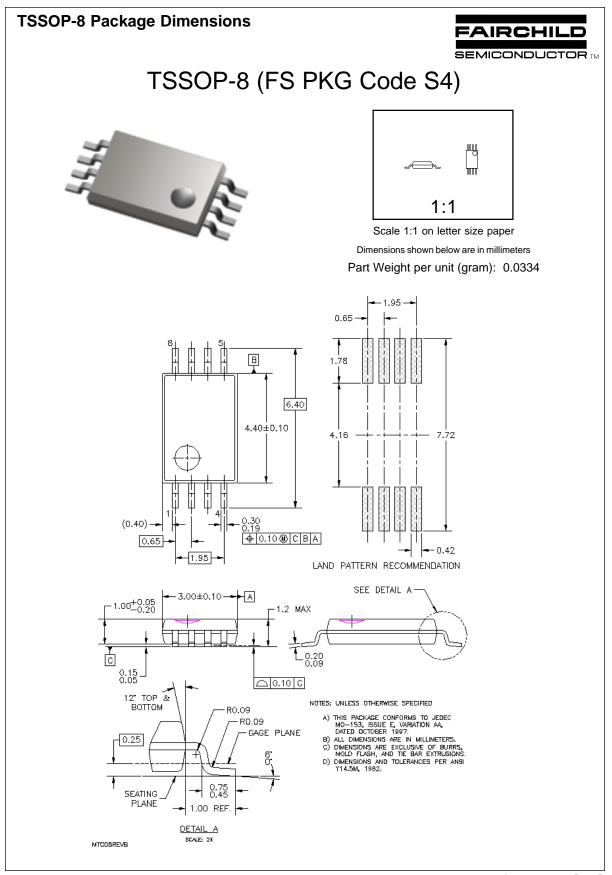
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